# SONY

# CXA3221AN

# **RX Gain Control Amplifier**

#### **Description**

CXA3221AN is an RX gain control amplifier suitable for CDMA cellular/PCS phone.

#### **Features**

- Wide gain control range
- · Linear gain slope
- Wideband operation (50MHz to 300MHz)
- Very small package (8 Pin SSOP)
- Low voltage operation
- · Power save function included



<ul> <li>Supply voltage</li> </ul>	Vcc	6	V
<ul> <li>Operating temperature</li> </ul>	Topr	-55 to +125	°C
<ul> <li>Storage temperature</li> </ul>	Tstg	-65 to +150	°C
<ul> <li>Supply voltage range</li> </ul>		-0.3 to 6	V
<ul> <li>Logic input voltage</li> </ul>	_	0.3 to Vcc + 0.	.3 V
<ul> <li>Signal input voltage</li> </ul>	_	0.3 to Vcc + 0.	.3 V
• Differential signal input voltage	Э	0 to 2.5	V

#### **Operating Condition**

Supply voltage

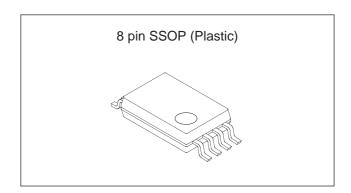
Vcc 2.7 to 3.8

#### **Applications**

CDMA cellular/PCS phone

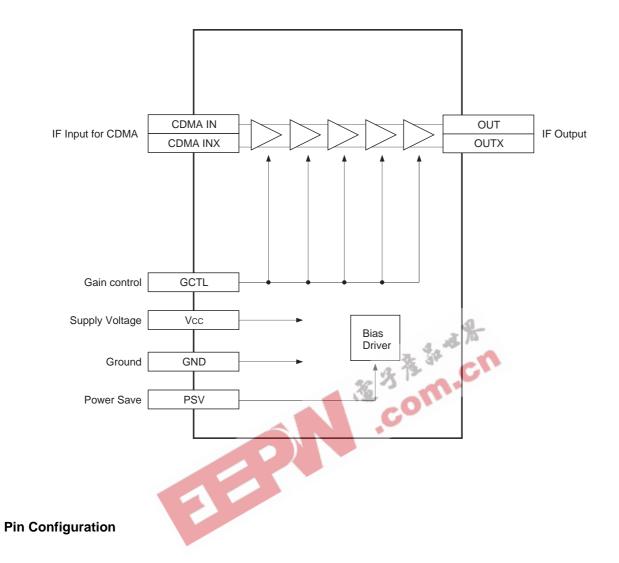
#### **Structure**

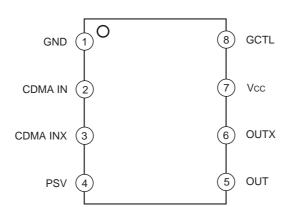
Bipolar silicon monolithic IC





## **Block Diagram**





# **Pin Description**

Pin No.	Symbol	Pin voltage TYP (V)	Equivalent circuit	Description
1	GND	0		Ground.
2	CDMA IN	1.15	Vcc 2k ₹ 2k	Differential input pins for received
3	CDMA INX	1.15	3 GND	CDMA IF signal.
4	PSV		4 Vcc GND	Power save function pin. High: Active Low: Power save
5	OUT	_	460 Vcc 5 12.3k 12.3k	Differential output pins for received CDMA IF signal.
6	OUTX	_	GND	Open collector output.
7	Vcc	3.0		Positive power supply.
8	GCTL	_	8 8 8 8 8 8 6 8 6 8 6 8 6 8 6 8 6 8 6 8	Gain control pin.

### **Electrical Characteristics**

### **DC Characteristics**

 $(Vcc = 3.0V, Ta = 27^{\circ}C)$ 

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Current consumption 1	lcc1	Vpsv = 3.0V, Vgctl = 1.5V, Pin 7	7	10.2	15	mA
Current consumption 2	lcc2	Vpsv = 0 V, Vgctl = 1.5V, Pin 7	5	18	40	
Input current pin 8H	IpsvH	Vpsv = 3.0V			1	
Input current pin 8L	IpsvL	Vpsv = 0 V	-15			μΑ
Input current pin 16H	IgctlH	Vgctl = 3.0V			1	
Input current pin 16L	IgctlL	Vgctl = 0.5V	-1			
PSV high voltage	VpsH	Pin 4	2.5			V
PSV low voltage	VpsL	Pin 4			0.5	

### **AC Characteristics**

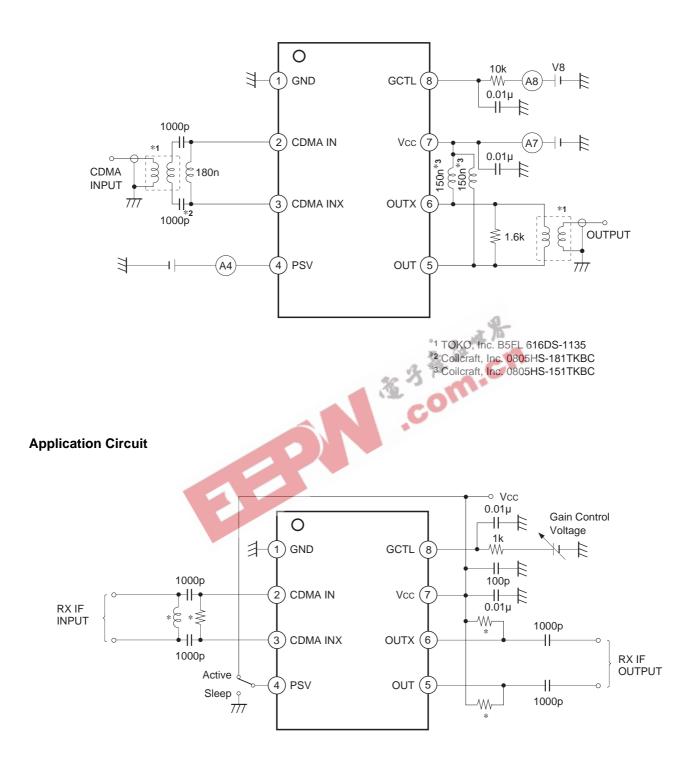
 $(Vcc = 3.0V, Ta = 27^{\circ}C)$ 

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Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating frequency range	Fr	3 3 3 T.C.	50		300	MHz
Gain 2.4	G2.4	f = 210.38MHz, Vgctl = 2.4V	42	46	50	
Gain 1.5	G1.5	Vgctl = 1.5V	-7	-3	1	dB
Gain 0.6	G0.6	Vgctl = 0.6V	-59	-55	-51	
Gain slope	GCLIN	Gain at Vgctl = 2.0V – Gain at Vgctl = 1.0V	58	61	64	dB/V
Input level 3rd order intercept point	IIP3	G = 40dB*1 f1 = 209.38MHz, f2 = 211.38MHz Measure of 210.38MHz	-42	-38		dBm
Noise Figure	NF	G = 40dB <sup>*1</sup> Measure of 210.38MHz		5	8	dB

<sup>\*1</sup> Adjust GCTL voltage, and set the overall gain to 40dB.

#### **Measurement Circuit**



<sup>\*</sup> Must be adjusting values to result a best impedance matching between BPF filter and this IC.

Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

### **Design Reference Values**

#### Single ended measurement

 $(Vcc = 3.0V, Ta = 27^{\circ}C)$ 

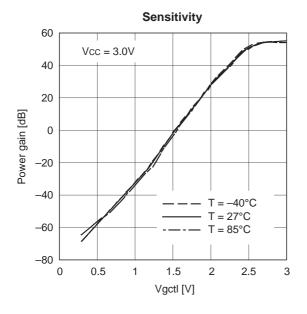
Item	Symbol	Conditions	Тур.	Unit
Input resistance	Rin		1.6	kΩ
Input capacitance	Cin	f = 210.38MHz, Vgctl = 1.5V	1.3	pF
Output resistance	Rout	1 = 210.36MHz, vgcti = 1.3V	5.9	kΩ
Output capacitance	Cout		0.73	pF

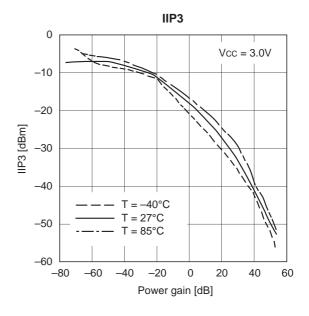
#### **Notes on Operation**

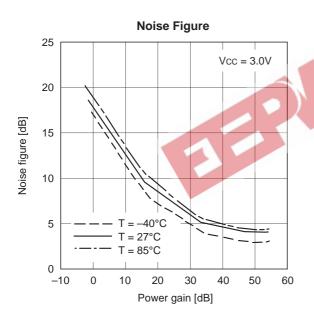
- 1) This IC is a wideband amplifier with wide gain control range. The decouping capacitors between GND Pin and Vcc Pin should be as close to the IC as possible.
- 2) The resistors connected to Pins 5 and 6 should be as close to the IC as possible.
- 3) This IC assumes the excellent characteristics when the differential input impedance between Pins 2 and 3 is ant setth 500Ω. Refer to the Measurement Circuit for the external element settings, etc.
- 4) Pay attention to handling this IC because its electrostatic discharge strength is weak.

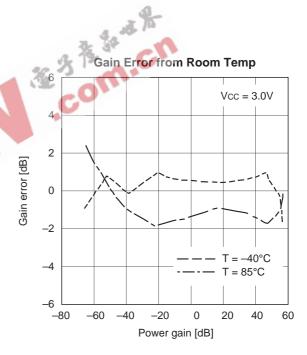


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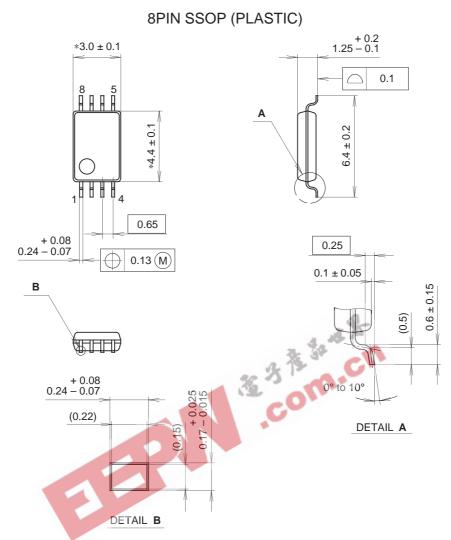








# Package Outline Unit: mm



NOTE: Dimension "\*" does not include mold protrusion.

SONY CODE	SSOP-8P-L01
EIAJ CODE	SSOP008-P-0044
JEDEC CODE	

#### PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER / PALLADIUM PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	0.04g